There are many applications where sensors, such as strength, distance, height, and pressure sensors, are used daily. Sensors are also heavily used in aerospace, intelligent manufacturing, and IoT. This special issue focuses on the advanced materials and processing technologies of sensors used in everyday life, manufacturing, and IoT applications, including materials, systems, design, and manufacturing techniques. The materials used can be carbon, metals, ceramics, polymers, and related composite materials. We also welcome papers on sensor applications of biomolecular materials, microorganisms, and various organic and inorganic materials.

**Scope:**
- Sensor design
- Sensor materials
- Sensor applications
- Sensor fabrication
- Intelligent sensors
- Sensors in life
- Sensors in manufacturing
- Sensors in IoT
- Sensors in systems
- Sensors in biomedicine

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